

PCN # 1370\_CANCELLATION

DATE: February 5, 2015

EXPECTED PCN SHIP DATE: April 8, 2019



Quality Assurance  
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San Jose, CA 95134

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**PROCESS CHANGE NOTICE**  
 **PRODUCT CHANGE NOTICE**

**MAXIM INTEGRATED** HEREBY ISSUES NOTIFICATION OF CHANGE  
THAT MAY AFFECT THE FOLLOWING CATEGORIES:

DESIGN     WAFER FAB     ASSEMBLY     TEST     ELEC/MECH SPECS

AFFECTED PRODUCT:

Ordering P/N: (See PN listing XLS in PCN ZIP file)

CHANGE FROM: Current assembler(s): UTAC Thai Limited (UTL) and/ or Carsem, Malaysia with nonconductive die attach epoxy for the SOT23 package, 3 thru 8 leads, leaded devices

CHANGE TO: Maxim is cancelling PCN 1370 issued 17 Feb 2014 for the Additional Assembler: Amkor Technology Philippines (ATP) with non-conductive die attach epoxy

JUSTIFICATION: Maxim Integrated has decided not to add ATP as an additional assembly vendor for the SOT23 packages.

TRACEABILITY: Maxim Integrated maintains full traceability by device marking, packaging labels and shipment documents.

Maxim Integrated's Change Notification System is designed to keep our customer base apprised of major product, manufacturing, or facility improvements.

*Nasser Ali Chaouche*

Nasser AliChaouche / PCN Coordinator

For further information, please contact either of the people listed below.

**Contact your local Maxim Integrated Company Representative**    or    Nasser AliChaouche, PCN Coordinator  
408-601-5660 / pcn.coordinator@maximintegrated.com